2SC1921

Silicon NPN Triple Diffused

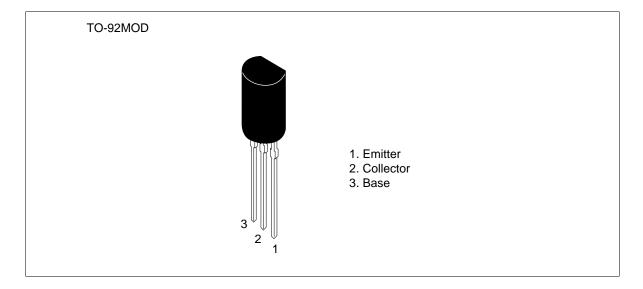
HITACHI

ADE-208-1060 (Z) 1st. Edition Mar. 2001

Application

- High frequency high voltage amplifier
- Video output

Outline





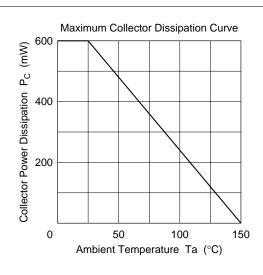
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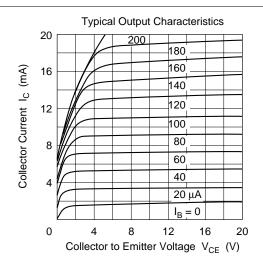
Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

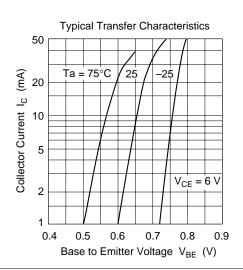
| Item | Symbol | Ratings | Unit |
|------------------------------|------------------|-------------|------|
| Collector to base voltage | V_{CBO} | 250 | V |
| Collector to emitter voltage | V _{CEO} | 200 | V |
| Emitter to base voltage | V_{EBO} | 5 | V |
| Collector current | Ic | 50 | mA |
| Collector power dissipation | P _c | 600 | mW |
| Junction temperature | Tj | 150 | °C |
| Storage temperature | Tstg | -55 to +150 | °C |

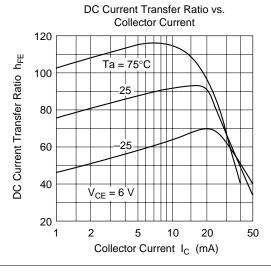
Electrical Characteristics ($Ta = 25^{\circ}C$)

| Item | Symbol | Min | Тур | Max | Unit | Test conditions |
|---|------------------|-----|-----|-----|------|--|
| Collector to base breakdown voltage | $V_{(BR)CBO}$ | 250 | _ | _ | V | $I_{c} = 10 \ \mu A, \ I_{E} = 0$ |
| Collector to emitter breakdown voltage | $V_{(BR)CEO}$ | 200 | _ | _ | V | I_{C} = 1 mA, R_{BE} = ∞ |
| Emitter to base breakdown voltage | $V_{(BR)EBO}$ | 5 | _ | _ | V | $I_{E} = 10 \ \mu A, \ I_{C} = 0$ |
| Collector cutoff current | I _{CEO} | _ | _ | 1.0 | μΑ | $V_{CE} = 120 \text{ V}, R_{BE} = \infty$ |
| DC current transfer ratio | h _{FE} | 30 | _ | 300 | | $V_{CE} = 6 \text{ V}, I_{C} = 10 \text{ mA}$ |
| Collector to emitter saturation voltage | $V_{CE(sat)}$ | _ | _ | 1.0 | V | $I_{\rm C}$ = 10 mA, $I_{\rm B}$ = 1 mA |
| Gain bandwidth product | f _T | 60 | 130 | _ | MHz | $V_{CE} = 6 \text{ V}, I_{C} = 10 \text{ mA}$ |
| Collector output capacitance | Cob | _ | 3 | 4 | pF | $V_{CB} = 6 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$ |

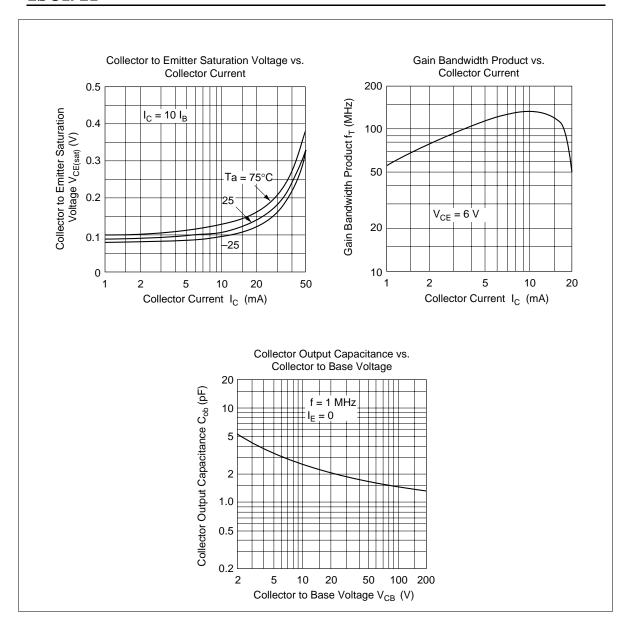




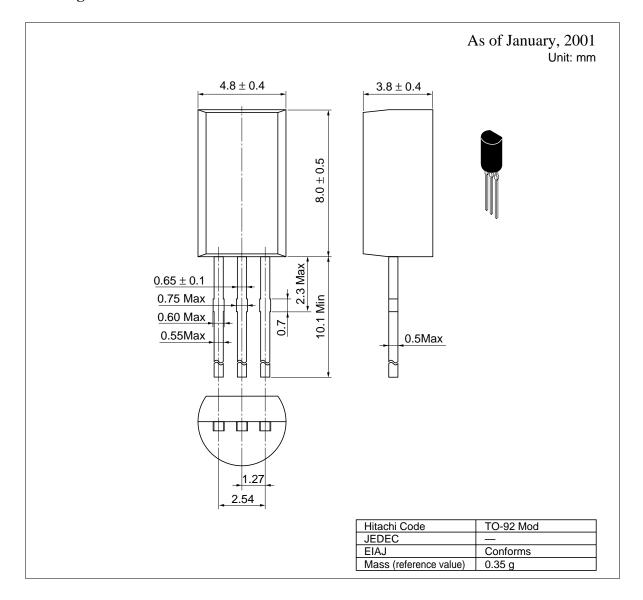




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Package Dimensions



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